ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® Internation	ial Composition I right 2005. IPC, Banno onal and Pan-American	<b>Declaration</b> ckburn, Illinois. A 1 copyright conve	All rights reserved u entions.	under both	This docume level parts, th	ent is a declaration he declaration er	on of the substance acompasses all lo	es within the ma wer level materia	nufacturer list als for which t	ed item. Note:	if the item is an as r has engineering	sembly with low responsibility.	
(5)_)	1 IPC Web Site for Information on IPC-1752 Standard Form Typ			Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				s Materials an	ials and Mfg Information			
upplier Information													
ompany name*	Company ur	Company unique ID			Unique ID Authority				Response Date*				
nsemi									2024-04-30				
ontact Name	Title - Conta	Title - Contact			Phone - Contact*			Ema	Email - Contact*				
Product-Env-Stewards	Product Env	Product Enviro Compliance			NA			Pro	Product-Env-Stewards@onsemi.com				
uthorized Representative*	Title - Repre	Title - Representative			Phone - Representative*			Ema	Email - Representative*				
roduct-Env-Stewards	Product Env	Product Enviro Compliance			NA			Pro	Product-Env-Stewards@onsemi.com				
Requester Item Nun	nber Mfr I	Mfr Item Number Mfr Item Name			E		Version	Manufacturing Site		Weight*	UOM	Unit Type	
	LC75836WS-T-E LCD I		LCD Display Driv	CD Display Driver		2024-04-30		РНМ		200.0	mg	Each	
Ianufacturing Proccess	Information	1											
Terminal Plating / Grid Array Material		Terminal Base	Terminal Base Alloy J-STD-020 MSI		Rating	Peak Process Body Temperature		ture Max Time	at Peak Temp	erature Num	ber of Reflow Cyc	cles	
contains Bi		CU Alloy	U Alloy 4			260 C 30		se	seconds 3				
omments													
or more information regarding	ng material compositi	on please refer t	o page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select	the Level (IIG A IIG B	Requester or Supplier) [B	l select the subst	ance category (JIG or Requester) or enter a	value (Supplier) [C] selec	t the substance (II	G) or enter the substa	nce and CAS (Other) [D
select a RoHS exemption, if applie	cable [E] enter the weigh	it of the substance or the P	PM concentration	[F] Optionally enter the positive (+) and ne	egative (-) tolerance in per	cent (Note: percer	it tolerance values are	expected to cover a 3
sigma range of distribution unless	otherwise noted).							
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.04	mg	Supplier	Silicon (Si)	7440-21-3		4.015	mg
			Supplier	Polyimide	Proprietary Data		0.025	mg
Die Attach	0.85	mg	Supplier	Silver (Ag)	7440-22-4		0.5783	mg
			Supplier	Epoxy resins	129915-35-1		0.2458	mg
			Supplier	Other Metal Oxide	Proprietary Data		0.0185	mg
			В	Antimony Pentoxide (Sb2O5)	1314-60-9		0.0073	mg
Lead Frame	67.8	mg	Supplier	Silver (Ag)	7440-22-4		1.078	mg
			Supplier	Zinc (Zn)	7440-66-6		0.1288	mg
			Supplier	Iron (Fe)	7439-89-6		1.7289	mg
			Supplier	Copper (Cu)	7440-50-8		64.7693	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0949	mg
Mold Compound-Black	123.4	mg		Epoxy resin	proprietary data		12.34	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		9.255	mg
			Supplier	Carbon Black (C)	1333-86-4		0.617	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		101.188	mg
Plating	2.77	mg	В	Bismuth (Bi)	7440-69-9		0.0166	mg
			Supplier	Tin (Sn)	7440-31-5		2.7534	mg
Wire Bond - Au	1.14	mg	Supplier	Gold (Au)	7440-57-5		1.14	mg